**Product / Process Change Notice**

**Parts Affected:**

Zener diodes manufactured in the SMA, SMB, SMC, DO-41 and DO-201 cases shown below:

|  |  |  |  |  |
| --- | --- | --- | --- | --- |
| SMA Case | SMB Case | SMC Case | DO-41 Case | DO-201 Case |
| CMZ5918B thru CMZ5956B | CMZ5918BP thru CMZ5956BP | CMZ5338B thru CMZ5388B | 1N5918B thru 1N5956B, 1N4734A thru 1N4764A | CZ5338B thru CZ5388B |

**Extent of Change:**

Addition of new wafer fab.

**Reason for Change:**

As part of Central Semiconductor’s supply chain risk mitigation initiative, and in an effort to ensure undisrupted product supply, an additional wafer fabrication site is being added for the referenced product families.  Product specifications, quality and reliability are not impacted by this addition.

**Effect of Change:**

This addition does not affect the fit, form or function of the devices.

**Qualification:**

|  |  |  |
| --- | --- | --- |
| **Test** | **Condition** | **Failure rate** |
| **Resistance to Solder Shock**  | T =260°C ±5°CDwell time = 10 sec.**JESD22-B106** | 0/77 |
| **High Temperature Storage Life/ bake test.** |  150°C (-0/+10)°C, 1000 hours.**JESD22-A103** | 0/77 |
| **Temperature Cycling** | T= -65°C to +150°C1000 cycles. Dwell time = 15 min.**JESD22-A104** | 0/77 |
| **High Temperature Reverse Bias (HTRB)** | T=125°C, t=1000 hours, VR=VZ**JESD22-A108** | 0/77 |
| **Highly Accelerated Temperature and Humidity Stress Test (HAST)** | T = 130°C, RH = 85%, P = 33.3 psia, and t = 96 hours.Bias conditions per device specification sheet.**JESD22-A110** | 0/77 |
| **Accelerated Moisture Resistance Unbiased Autoclave** | Temperature = 121°C ± 2°C; relative humidity = 100%; vapor pressure = 29.7 psia (15psig). t=96 hours**JESD22-A102** | 0/77 |

**Effective Date of Change:**

Existing inventory will be shipped until depleted.

**Sample Availability:**

Please contact your salesperson or manufacturer’s representative for samples.

As per JEDEC standard JESD46, Customer Notification of Product/Process Changes by Solid-State Suppliers, a lack of acknowledgement of a PCN within thirty (30) days constitutes acceptance of the change.

The undersigned acknowledges and accepts Central Semiconductor’s Product/Process Change Notification (PCN).

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| Company Name: |  |
| Address: |  |
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| Printed Name: |  |
| Title: |  |
| Signature: |  |
| Date: |  |